



Data sheet acquired from Harris Semiconductor SCHS198C

November 1997 - Revised May 2003

High Speed CMOS Logic Dual 4-Stage Static Shift Register

Features

- Maximum Frequency, Typically 60MHz
 C_L = 15pF, V_{CC} = 5V, T_A = 25°C
- · Positive-Edge Clocking
- Overriding Reset
- · Buffered Inputs and Outputs
- Fanout (Over Temperature Range)
- Wide Operating Temperature Range ... -55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
 - 2V to 6V Operation
 - High Noise Immunity: N_{IL} = 30%, N_{IH} = 30% of V_{CC} at V_{CC} = 5V

Description

The 'HC4015 consists of two identical, independent, 4-stage serial-input/parallel-output registers. Each register has independent Clock (CP) and Reset (MR) inputs as well as a single serial Data input. "Q" outputs are available from each of the four stages on both registers. All register stages are D-type, master-slave flip-flops. The logic level present at the Data input is transferred into the first register stage and shifted over one stage at each positive- going clock transition. Resetting of all stages is accomplished by a high level on the reset line.

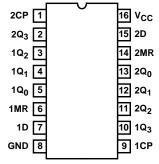
The device can drive up to 10 low power Schottky equivalent loads. The 'HC4015 is an enhanced version of equivalent CMOS types.

Ordering Information

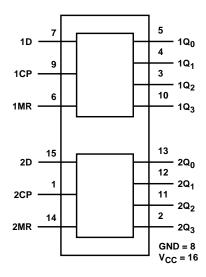
PART NUMBER	TEMP. RANGE (°C)	PACKAGE
CD54HC4015F3A	-55 to 125	16 Ld CERDIP
CD74HC4015E	-55 to 125	16 Ld PDIP
CD74HC4015M	-55 to 125	16 Ld SOIC

Pinout

CD54HC4015 (CERDIP) CD74HC4015 (PDIP, SOIC) TOP VIEW



Functional Diagram



TRUTH TABLE

	INPUTS		OUTPUTS							
СР	D	R	Q ₀	Q ₁	Q ₂	Q_3				
1	I	L	L	q' ₀	q' ₁	q' ₂				
1	h	L	Н	q' ₀	q' ₁	q' ₂				
\downarrow	Х	L	q'o	q' ₁	q' ₂	q'3				
Х	Х	Н	L	L	L	L				

H = High Voltage Level

h = High Voltage Level One Set-up Time Prior to the Low to High Clock Transition

L = Low Voltage Level

I = Low Voltage Level One Set-up Time Prior to the Low to High Clock Transition

X = Don't Care.

↑ = Low to High Clock Transition

 \downarrow = High to Low Clock Transition

 q'_n = Lower case letters indicate the state of the referenced output one set-up time prior to the Low to High clock transition.

CD54HC4015, CD74HC4015

Absolute Maximum Ratings Thermal Information θ_{JA} (°C/W) DC Supply Voltage, V_{CC}-0.5V to 7V Thermal Resistance (Typical, Note 1) DC Input Diode Current, I_{IK} M (SOIC) Package..... DC Output Diode Current, IOK For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$±20mA Maximum Storage Temperature Range-65°C to 150°C DC Output Source or Sink Current per Output Pin, IO Maximum Lead Temperature (Soldering 10s)......300°C (SOIC - Lead Tips Only) **Operating Conditions** Temperature Range, T_A -55°C to 125°C Supply Voltage Range, V_{CC} HC Types2V to 6V DC Input or Output Voltage, V_I, V_O 0V to V_{CC} Input Rise and Fall Time 4.5V...... 500ns (Max)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE

1. The package thermal impedance is calculated in accordance with JESD 51-7.

DC Electrical Specifications

		TEST CONDITIONS		v _{cc}	25°C			-40°C TO 85°C		-55°C TO 125°C											
PARAMETER S	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS									
High Level Input	V _{IH}	-	-	2	1.5	-	-	1.5	-	1.5	-	V									
Voltage				4.5	3.15	-	-	3.15	-	3.15	-	V									
				6	4.2	-	-	4.2	-	4.2	-	V									
Low Level Input	V _{IL}	-	-	2	-	-	0.5	-	0.5	-	0.5	V									
Voltage				4.5	-	-	1.35	-	1.35	-	1.35	V									
				6	-	-	1.8	-	1.8	-	1.8	V									
High Level Output	V _{OH}	V _{IH} or V _{IL}	-0.02	2	1.9	-	-	1.9	-	1.9	-	V									
Voltage CMOS Loads			-0.02	4.5	4.4	-	-	4.4	-	4.4	-	V									
			-0.02	6	5.9	-	-	5.9	-	5.9	-	V									
High Level Output	1		-	-	-	-	-	-	-	-	-	٧									
Voltage TTL Loads			-4	4.5	3.98	-	-	3.84	-	3.7	-	٧									
1.12 20000			-5.2	6	5.48	-	-	5.34	-	5.2	-	٧									
Low Level Output	V _{OL}	V _{IH} or V _{IL}	0.02	2	-	-	0.1	-	0.1	-	0.1	٧									
Voltage CMOS Loads			0.02	4.5	-	-	0.1	-	0.1	-	0.1	٧									
000 2000			0.02	6	-	-	0.1	-	0.1	-	0.1	٧									
Low Level Output	1											-	-	-	-	-	-	-	-	-	٧
Voltage TTL Loads			4	4.5	-	-	0.26	-	0.33	-	0.4	٧									
I I L LOGUS			5.2	6	-	-	0.26	-	0.33	-	0.4	٧									
Input Leakage Current	Ι _Ι	V _{CC} or GND	-	6	-	-	±0.1	-	±1	-	±1	μΑ									
Quiescent Device Current	Icc	V _{CC} or GND	0	6	-	ı	8	-	80	-	160	μΑ									

CD54HC4015, CD74HC4015

Prerequisite for Switching Specifications

			25	°С	-40°C T	O 85°C	-55°C T		
PARAMETER	SYMBOL	V _{CC} (V)	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
Maximum Clock	f _{MAX}	2	6	-	5	-	4	-	MHz
Frequency		4.5	30	-	24	-	20	-	MHz
		6	35	-	28	-	24	-	MHz
Clock Pulse Width	t _W	2	80	-	100	-	120	-	ns
		4.5	16	-	20	-	24	-	ns
		6	14	-	17	-	20	-	ns
MR Pulse Width	t _W	2	150	-	190	-	225	-	ns
		4.5	30	-	38	-	45	-	ns
		6	26	-	33	-	38	-	ns
MR Recovery Time	tREC	2	50	-	65	-	75	-	ns
		4.5	10	-	13	-	15	-	ns
		6	9	-	11	-	13	-	ns
Set-up Time,	tsul, tsuh	2	60	-	75	-	90	-	ns
Data-In to CP		4.5	12	-	15	-	18	-	ns
		6	10	-	13	-	15	-	ns
Hold Time,	tH	2	0	-	0	-	0	-	ns
Data-In to CP		4.5	0	-	0	-	0	-	ns
		6	0	-	0	-	0	-	ns

Switching Specifications Input t_r , $t_f = 6ns$

		TEST	V _{CC}	25°C			-40°C T	O 85°C	-55°C T		
PARAMETER	SYMBOL	CONDITIONS	(V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
Propagation Delay (Figure 1)	t _{PLH,}	C _L = 50pF	2	-	-	175	-	220	-	270	ns
Clock to Q _n	t _{PHL}		4.5	-	-	35	-	44	-	54	ns
		C _L =15pF	5	-	14	-	-	-	-	-	ns
		C _L = 50pF	6	-	-	30	-	37	-	46	ns
MR to Q _n , (Clock High)	t _{PLH} ,	C _L = 50pF	2	-	-	275	-	345	-	415	ns
	t _{PHL}		4.5	-	-	55	-	64	-	83	ns
		C _L =15pF			25	-	-	-	-	-	ns
		C _L = 50pF	6	-	-	47	-	54	-	71	ns
MR to Q _n , (Clock Low)	t _{PLH} ,	C _L = 50pF	2	-	-	325	-	400	-	490	ns
	t _{PHL}		4.5	-	-	65	-	81	-	98	ns
		C _L =15pF			25	-	-	-	-	-	ns
		C _L = 50pF	6	-	-	55	-	69	-	83	ns
Output Transition Time	t _{TLH} , t _{THL}	C _L = 50pF	2	-	-	75	-	95	-	110	ns
(Figure 1)			4.5	-	-	15	-	19	-	22	ns
			6	-	-	13	-	16	-	19	ns
Input Capacitance	C _{IN}	C _L = 50pF	-	-	-	10	-	10	-	10	pF
Maximum Clock Frequency	f _{MAX}	C _L =15pF	5	-	60	-	-	-	-	-	MHz
Power Dissipation Capacitance (Notes 2, 3)	C _{PD}	C _L =15pF	5	-	43	-	-	-	-	-	pF

- 2. C_{PD} is used to determine the dynamic power consumption, per shift register.

 3. $P_D = V_{CC}^2 f_i + \sum C_L V_{CC}^2$ where f_i = Input Frequency, C_L = Output Load Capacitance, V_{CC} = Supply Voltage.

Test Circuit and Waveform

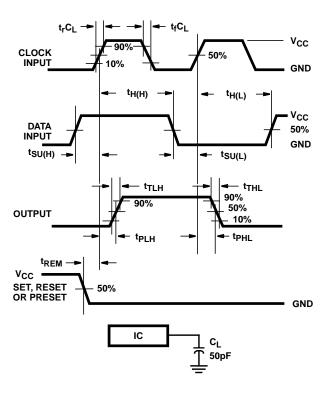


FIGURE 1. HC SETUP TIMES, HOLD TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR EDGE TRIGGERED SEQUENTIAL LOGIC CIRCUITS





6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Q.,	(2)	(6)	(3)		(4/5)	
5962-8995301EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8995301EA CD54HC4015F3A	Samples
CD54HC4015F3A	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8995301EA CD54HC4015F3A	Samples
CD74HC4015E	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	-55 to 125	CD74HC4015E	Samples
CD74HC4015M	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4015M	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF CD54HC4015, CD74HC4015:

• Military: CD54HC4015

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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